#### SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR) SP!'供应商

#### 

- Cascading Circuitry Provided Internally
- Synchronous Operation
- Individual Preset to Each Flip-Flop
- Fully Independent Clear Input

SN54192, SN54193, SN54LS192, SN54LS193...J OR W PACKAGE SN74192, SN74193...N PACKAGE SN74LS192, SN74LS193...D OR N PACKAGE (TOP VIEW)

TYPES	TYPICAL MAXIMUM	TYPICAL
	COUNT FREQUENCY	POWER DISSIPATION
<b>'</b> 192,'193	32 MHz	325 mW
'LS192,'LS193	32 MHz	95 mW

#### description

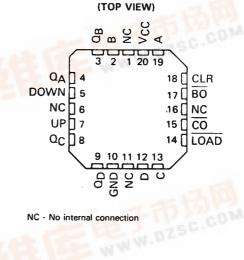
These monolithic circuits are synchronous reversible (up/down) counters having a complexity of 55 equivalent gates. The '192 and 'LS192 circuits are BCD counters and the '193 and 'LS193 are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincidently with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes which are normally associated with asynchronous (rippleclock) counters.

The outputs of the four master-slave flip-flops are triggered by a low-to-high-level transition of either count (clock) input. The direction of counting is determined by which count input is pulsed while the other count input is high.

All four counters are fully programmable; that is, each output may be preset to either level by entering the desired data at the data inputs while the load input is low. The output will change to agree with the data inputs independently of the count pulses. This feature

U <sub>16</sub>	Dvcc
15	<b>A</b>
14	
13	ВО
12	
11	LOAD
10	]C
9	٦D
	14 13 12 11

### SN54LS192, SN54LS193 . . . FK PACKAGE



allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

A clear input has been provided which forces all outputs to the low level when a high level is applied. The clear function is independent of the count and load inputs. The clear, count, and load inputs are buffered to lower the drive requirements. This reduces the number of clock drivers, etc., required for long words.

These counters were designed to be cascaded without the need for external circuitry. Both borrow and carry outputs are available to cascade both the up- and down-counting functions. The borrow output produces a pulse equal in width to the count-down input when the counter underflows. Similarly, the carry output produces a pulse equal in width to the count-up input when an overflow condition exists. The counters can then be easily cascaded by feeding the borrow and carry outputs to the count-down and count-up inputs respectively of the succeeding counter.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

7 - 5 10 14	SN54'	SN54LS'	SN74'	SN74LS'	UNIT
Supply voltage, V <sub>CC</sub> (see Note 1)	7	7	7	7	V
Input voltage	5.5	7	5.5	7	V
Operating free-air temperature range	- 55	to 125	0	to 70	°C
Storage temperature range	- 65	to 150	-65	to 150	°C

NOTE 1: Voltage values are with respect to network ground terminal.

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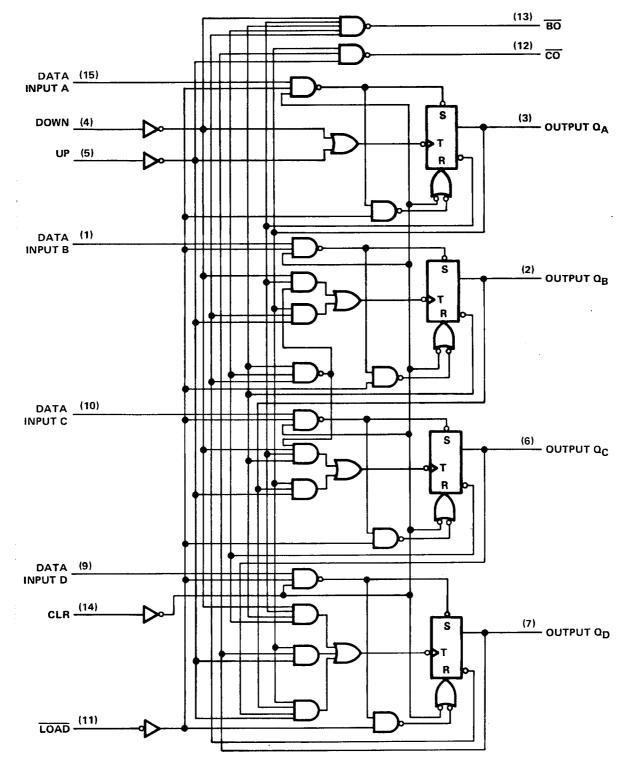


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### SN54192, SN54LS192, SN74192, SN74LS192 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

#### SDLS

#### logic diagram (positive logic)



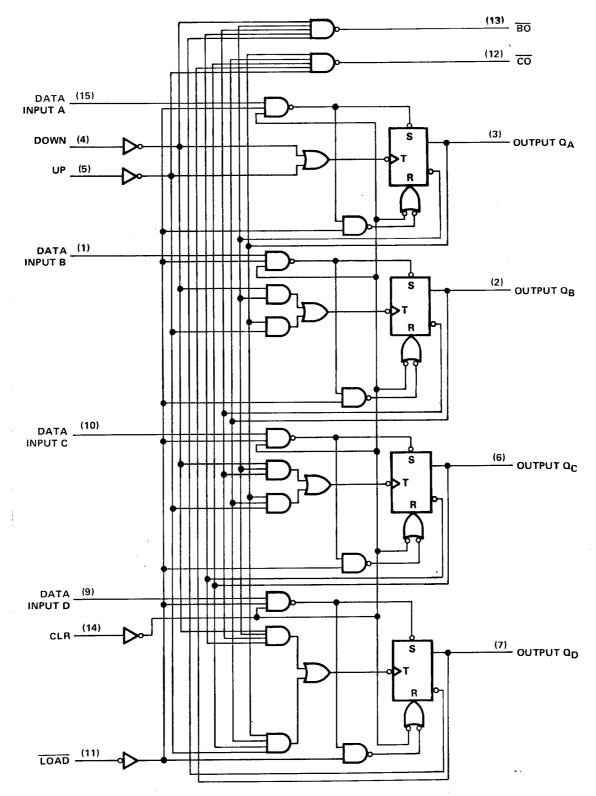
Pin numbers shown are for D, J, N, and W packages.



<u> 查询"SN54LS193-SP"供应商</u>

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#### logic diagram (positive logic)



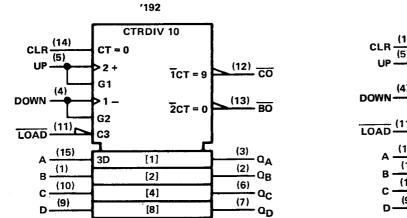
Pin numbers shown are for D, J, N, and W packages.

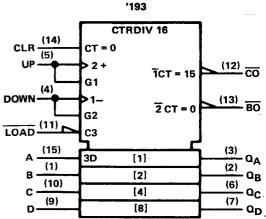


### SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

SDLS224 TUS NUMBERS 1923- REVISED TO ABO H 1988

#### logic symbols<sup>†</sup>

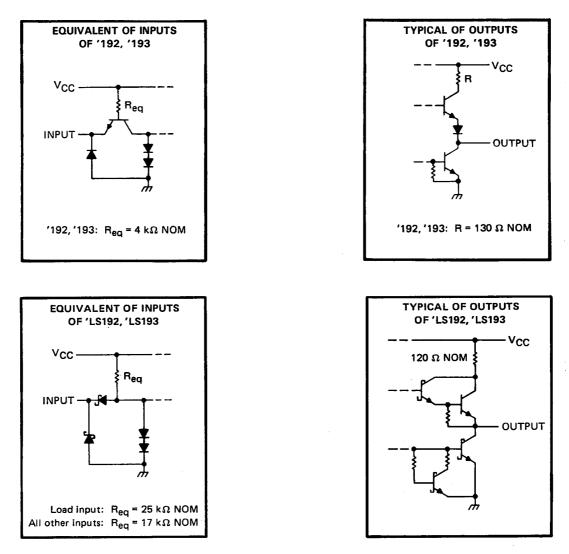




 $^{\dagger} \text{These}$  symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

#### schematics of inputs and outputs





#### <u> 查询"SN54LS193-SP"供应商</u>

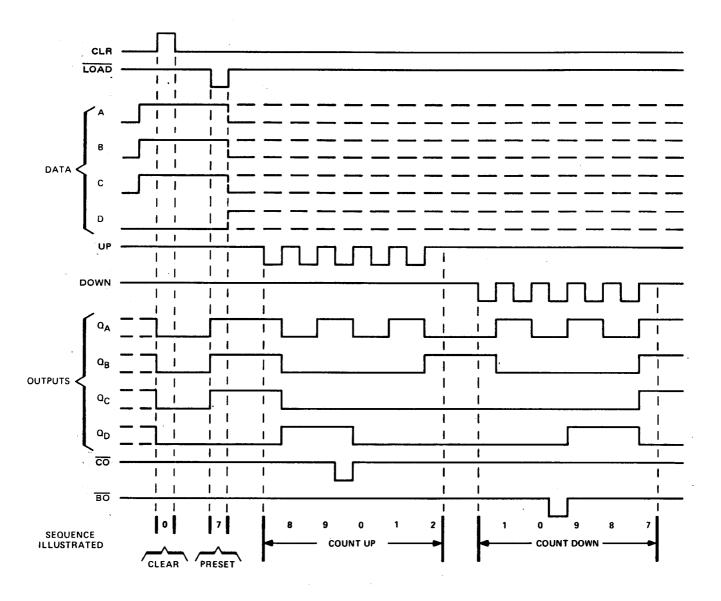
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#### '192, 'LS192 DECADE COUNTERS

#### typical clear, load, and count sequences

Illustrated below is the following sequence:

- 1. Clear outputs to zero.
- 2. Load (preset) to BCD seven.
- 3. Count up to eight, nine, carry, zero, one, and two.
- 4. Count down to one, zero, borrow, nine, eight, and seven.



NOTES: A. Clear overrides load, data, and count inputs.

B. When counting up, count-down input must be high; when counting down, count-up input must be high.



### SN54193, SN54LS193, SN74193, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

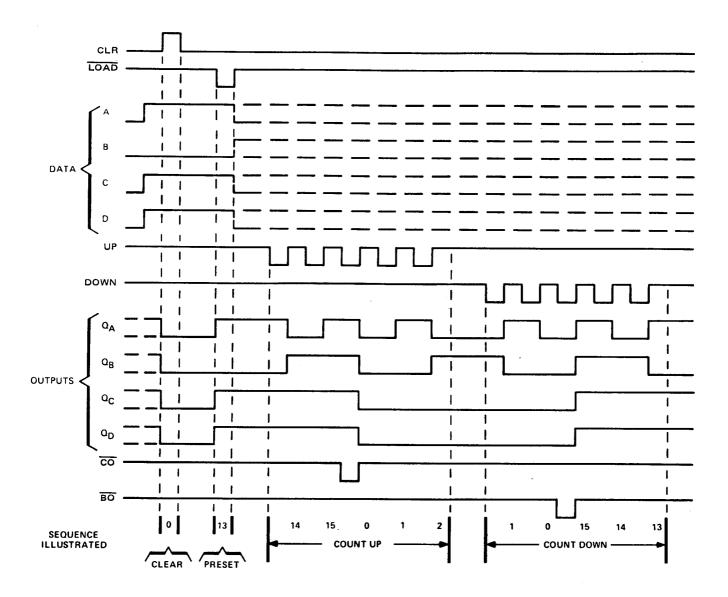
SDLS

#### '193, 'LS193 BINARY COUNTERS

#### typical clear, load, and count sequences

Illustrated below is the following sequence:

- 1. Clear outputs to zero.
- 2. Load (preset) to binary thirteen.
- 3. Count up to fourteen, fifteen, carry, zero, one, and two.
- 4. Count down to one, zero, borrow, fifteen, fourteen, and thirteen.



NOTES: A. Clear overrides load, data, and count inputs.

B. When counting up, count-down input must be high; when counting down, count-up input must be high.



### SN54192, SN54193, SN74192, SN74193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

#### <u> 查询"SN54L S193-SP"供应商</u>

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#### recommended operating conditions

				SN5419 SN5419			SN7419 SN7419		
			MIN	NOM	MAX	MIN	NOM	MAX	
Vcc	Supply voltage	······································	4.5	5	5.5	4.75	5	5.25	V
юн	High-level output current	· · · · · · · · · · · · · · · · · · ·			-0.4			-0.4	mA
<b>I</b> OL	Low-level output current	· · · · · · · · · · · · · · · · · · ·			16			16	mA
fclock	Clock frequency		0		25	0		25	MHz
tw	Width of any input pulse	·····	20		-	20			ns
t <sub>su</sub>	Data setup time, (see Figure 1)	<u> </u>	20			20			ns
<b>.</b>	Hold time	Data, high or low	0	-		0			
th	Hold time	LOAD	3			3			ns
ТА	Operating free-air temperature		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN5419	2		SN7419	2	
	PARAMETER	TEST CONDITIONS <sup>†</sup>		SN5419	3		SN7419	3	UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage		2			2	•		V
VIL	Low-level input voltage				0.8			0.8	V
VIK	Input clamp voitage	$V_{CC} = MIN$ , $I_I = -12 \text{ mA}$			-1.5			-1.5	V
v <sub>он</sub>	High-level output voltage	$V_{CC} = MIN, V_{IH} = 2V,$ $V_{1L} = 0.8V, I_{OH} = -0.4 \text{ mA}$	2.4	3.4		2.4	3.4		v
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	v
٦ <sub>ل</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>1</sub> = 5.5 V			1			1	mA
ЧН	High-level input current	V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.4 V			40			40	μA
<sup>I</sup> IL	Low-level input current	V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4 V			-1.6			-1.6	mA
los	Short-circuit output current§	V <sub>CC</sub> = MAX	20		-65	-18		-65	mA
1cc	Supply current	V <sub>CC</sub> = MAX, See Note 2		65	89		65	102	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. <sup>‡</sup>All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

 $\S{}Not more than one output should be shorted at a time.$ 

NOTE 2: I<sub>CC</sub> is measured with all outputs open, clear and load inputs grounded, and all other inputs at 4.5 V.

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

PARAMETER¶	FROM INPUT	TO OUTPUT	TEST CONDITIONS	MIN	түр	MAX	UNIT
f <sub>max</sub>				25	32		MHz
<sup>t</sup> PLH	LID.	co	7		17	26	
<sup>t</sup> PHL	UP	CO			16	24	ns
<sup>t</sup> PLH	DOWN	BO	С <b>L = 15</b> рF,		16	24	
<sup>t</sup> PHL	DOWN	во	$R_{L} = 400 \Omega,$		16	24	4 ns
<sup>t</sup> PLH		Q	See Figures 1 and 2		25	38	
<sup>t</sup> PHL	UP OR DOWN	ŭ			31	47	ns
tPLH		0	7		27	40	
<sup>t</sup> PHL	LOAD	Q			29	40	ns
tPHL	CLR	Q	7		22	35	ns

¶f<sub>max</sub> ≡ maximum clock frequency

tpLH = propagation delay time, low-to-high-level output

tPHL ≡ propagation delay time, high-to-low-level output



### SN54LS192, SN54LS193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

SDLS

#### recommended operating conditions

			N54LS1 N54LS1		SN74LS192 SN74LS193			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	]
Vcc	Supply voltage	4.5	. 5	5.5	4.75	5	5.25	V
юн	High-level output current			-400			-400	μA
IOL	Low-level output current			4			8	mA
fclock	Clock frequency	0		25	0		25	MHz
tw	Width of any input pulse	20			20		•	ns
	Clear inactive-state setup time	15			15			ns
t <sub>su</sub>	Load inactive-state setup time	15			15			ns
Ĩ	Data setup time (see Figure 1)	20			20			ns
th	Data hold time	5			5			ns
TA	Operating free-air temperature range	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

L

	PARAMETER	TE	ST CONDITIONS	;†	ł .	N54LS1 N54LS1			N74LS1 N74LS1		UNIT
			•.		MIN	TYP‡	MAX	MIN	ТҮР‡	MAX	
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> =18 mA				-1.5			-1.5	v
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max	V <sub>IH</sub> = 2 V, , 1 <sub>OH</sub> = -400 μA	N <sup>1</sup>	2.5	3.4		2.7	3.4		v
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 4 mA I <sub>OL</sub> = 8 mA		0.25	0.4		0.15 0.35	0.4 0.5	v
lı	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V; = 7 V				0.1			0.1	(mA
łн	High-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V				20			20	μA
կլ	Low-level input current	V <sub>CC</sub> = MAX,	VI = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current§	V <sub>CC</sub> = MAX			20		-100	-20		-100	mA
Icc	Supply current	V <sub>CC</sub> = MAX,	See Note 2			19	34		19	-34	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. <sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

\$Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: I<sub>CC</sub> is measured with all outputs open, clear and load inputs grounded, and all other inputs at 4.5 V.

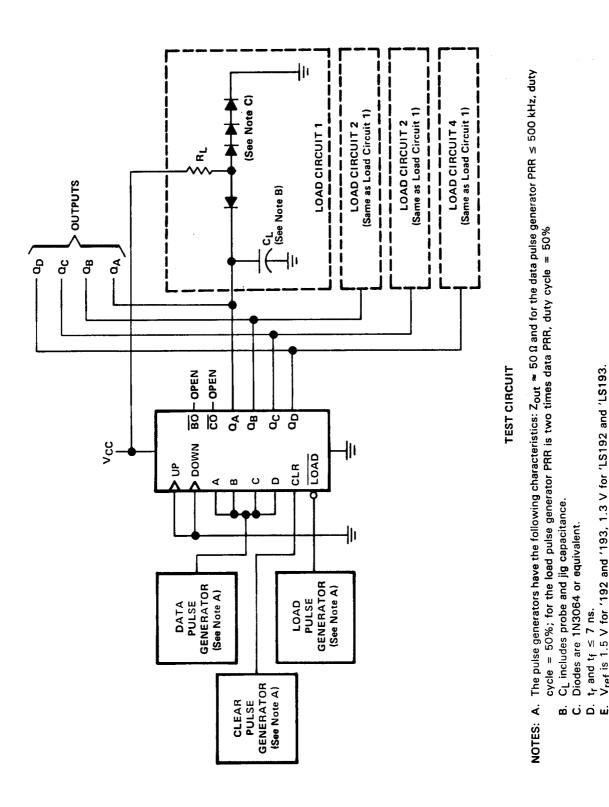
#### switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PARAMETER	FROM INPUT	το ουτρυτ	TEST CONDITIONS	MIN	түр	MAX	UNIT
f <sub>max</sub>				25	32		MHz
tPLH	LID	<u>co</u>	7		17	26	
tPHL	- UP	0			18	24	ns
<sup>t</sup> PLH	DOWN	BO	C <sub>L</sub> = 15 pF,		16	24	
tPHL	DOWN	во	$= R_{L} = 2 k\Omega,$		15	24	ns
<sup>t</sup> PLH		0	See Figures 1 and 2		27	38	
tPHL	UP OR DOWN	Q			30	47	ns
tPLH			-		24	40	
tPHL	LOAD	۵			25	40	ns
tPHL	CLR	Q	7		23	35	ns



# SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR) 查询"SN54LS193-SP"供应商 SDLS074 - DECEMBER 1972 - REVISED MARCH 1988

#### PARAMETER MEASUREMENT INFORMATION





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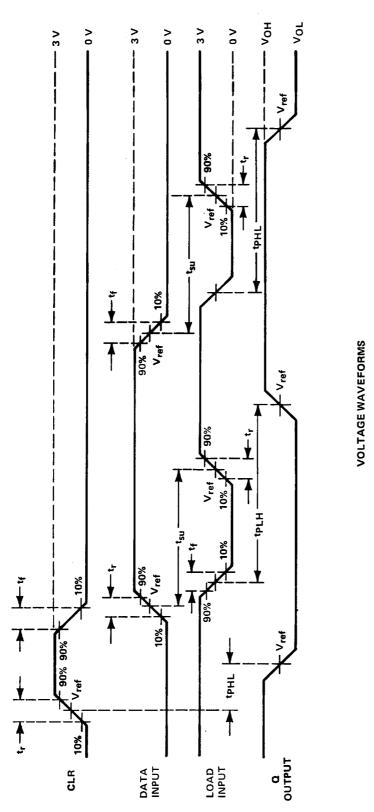
FIGURE 1A -- CLEAR, SETUP AND LOAD TIMES

 $\dot{V}_{ref}$  is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

 $t_r$  and  $t_f \leq 7$  ns.

#### PARAMETER MEASUREMENT INFORMATION

SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)



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- Diodes are 1N3064 or equivalent. ப்ப்ப்
  - $t_{f}$  and  $t_{f} \leq 7$  ns.
- V<sub>ref</sub> is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 1B - CLEAR, SETUP, AND LOAD TIMES

10

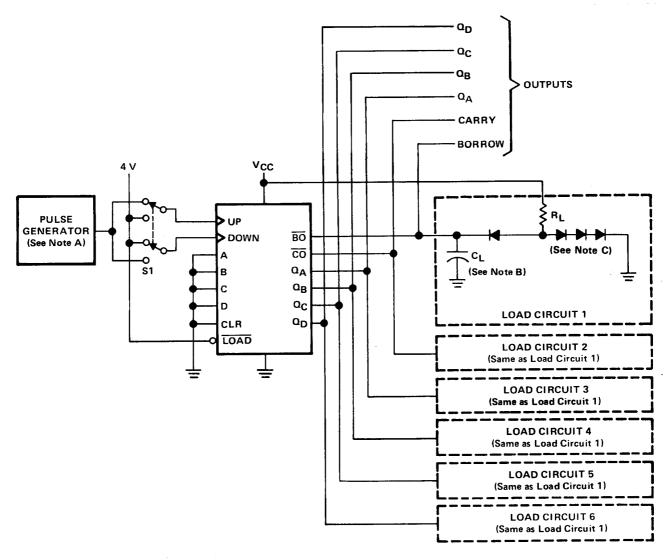
# SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193

SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

查询"SN54L S193-SP"供应函

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#### PARAMETER MEASUREMENT INFORMATION



#### **TEST CIRCUIT**

NOTES: A. The pulse generators have the following characteristics: PRR  $\approx$  1 MHz, Z<sub>out</sub>  $\approx$  50  $\Omega$ , duty cycle = 50%.

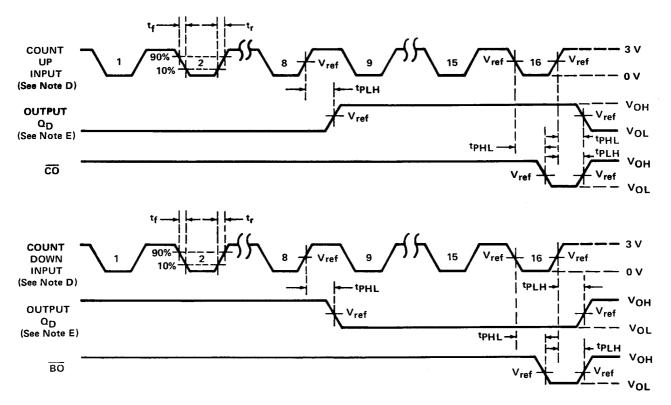
- B.  $C_{\mbox{L}}$  includes probe and jig capacitance.
- C. Diodes are 1N3064 or equivalent.
- D. Cout-up and dount-down pulse shown are for the '193 and 'LS193 binary counters. Count cycle for '192 and 'LS192 decade counters is 1 through 10.
- E. Waveforms for outputs  $Q_A$ ,  $Q_B$ , and  $Q_C$  are omitted to simplify the drawing.
- F.  $t_r$  and  $t_f \leq 7$  ns.
- G. V<sub>ref</sub> is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 2A - PROPAGATION DELAY TIMES



### SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

#### PARAMETER MEASUREMENT INFORMATION



**VOLTAGE WAVEFORMS** 

- NOTES: A. The pulse generators have the following characteristics: PRR  $\approx$  1 MHz, Z<sub>out</sub>  $\approx$  50  $\Omega$ , duty cycle = 50%.
  - B. CL includes probe and jig capacitance.
  - C. Diodes are 1N3064 or equivalent.
  - D. Cout-up and dount-down pulse shown are for the '193 and 'LS193 binary counters. Count cycle for '192 and 'LS192 decade counters is 1 through 10.
  - E. Waveforms for outputs  $Q_A$ ,  $Q_B$ , and  $Q_C$  are omitted to simplify the drawing.
  - F.  $t_r$  and  $t_f \leq 7$  ns.
  - G. V<sub>ref</sub> is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 2B - PROPAGATION DELAY TIMES







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#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Pe
5962-9558401QEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
5962-9558401QFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
5962-9558401QFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
76006012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pk
76006012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pk
7600601EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
7600601EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
7600601FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
7600601FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
JM38510/01309BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
JM38510/01309BEA	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
JM38510/31508B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pk
JM38510/31508B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pk
JM38510/31508BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
JM38510/31508BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
JM38510/31508BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
JM38510/31508BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
JM38510/31508SEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
JM38510/31508SEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
JM38510/31508SFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
JM38510/31508SFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
SN54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SN54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SN54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SN54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SN74192N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI

PACKAG



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Orderable Device	Status <sup>(1)</sup> F	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Pe
SN74192N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74193N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74193N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74193N3	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74193N3	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74LS192D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS192D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS192N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74LS192N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74LS193D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193J	OBSOLETE	CDIP	J	16	· ·	TBD	Call TI	Call TI

## PACKAG



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Pe
SN74LS193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS193N	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pk
SN74LS193N	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pk
SN74LS193N3	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74LS193N3	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74LS193NE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pk
SN74LS193NE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pk
SN74LS193NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SN74LS193NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260
SNJ54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SNJ54192J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SNJ54192W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
SNJ54192W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
SNJ54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54193J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54193W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54193W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54LS193FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pk
SNJ54LS193FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pk
SNJ54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SNJ54LS193J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pk
SNJ54LS193W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk
SNJ54LS193W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pk



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<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new **PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www. information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retard in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF SN54192, SN54193, SN54LS193, SN54LS193-SP, SN74192, SN74193, SN74LS193 :

- Catalog: SN74192, SN74193, SN74LS193, SN54LS193
- Military: SN54192, SN54193, SN54LS193
- Space: SN54LS193-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

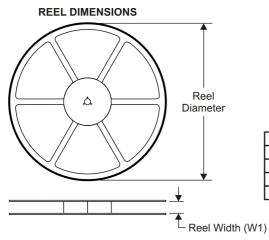


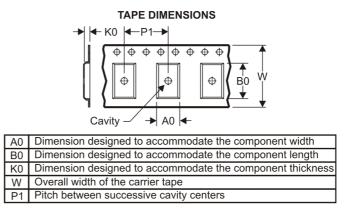
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• Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

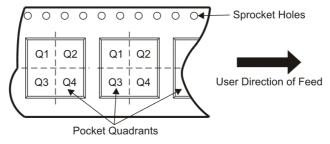
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### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

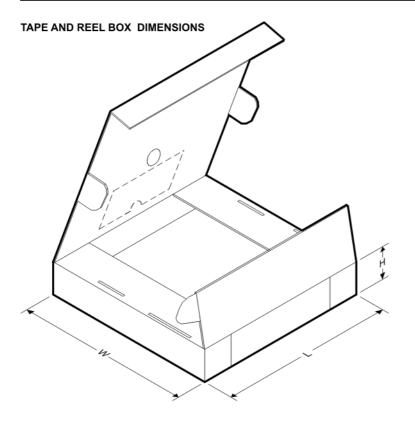


*A	l dimensions are nominal												
	Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS193DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
	SN74LS193NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



### PACKAGE MATERIALS INFORMATION

19-Mar-2008

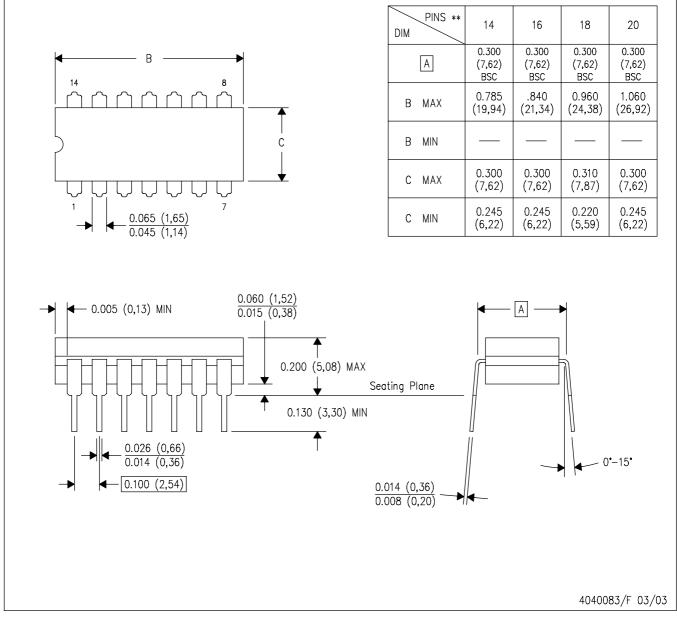


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS193DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS193NSR	SO	NS	16	2000	346.0	346.0	33.0

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE

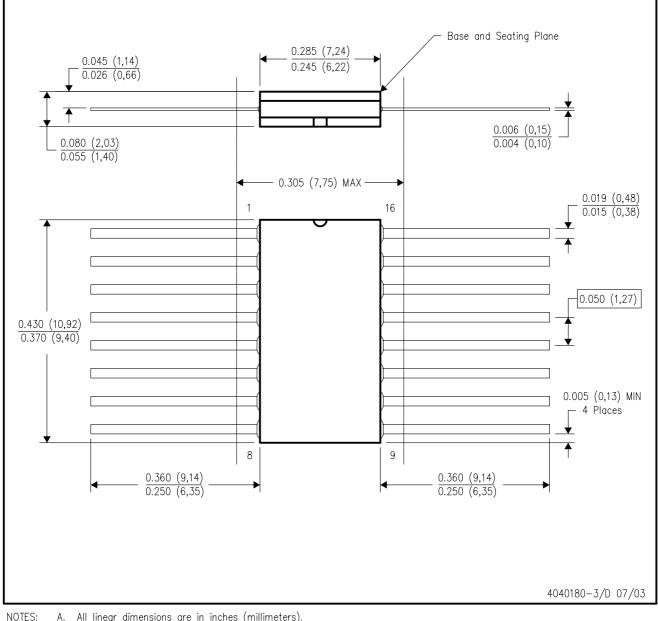


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

### W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice. C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



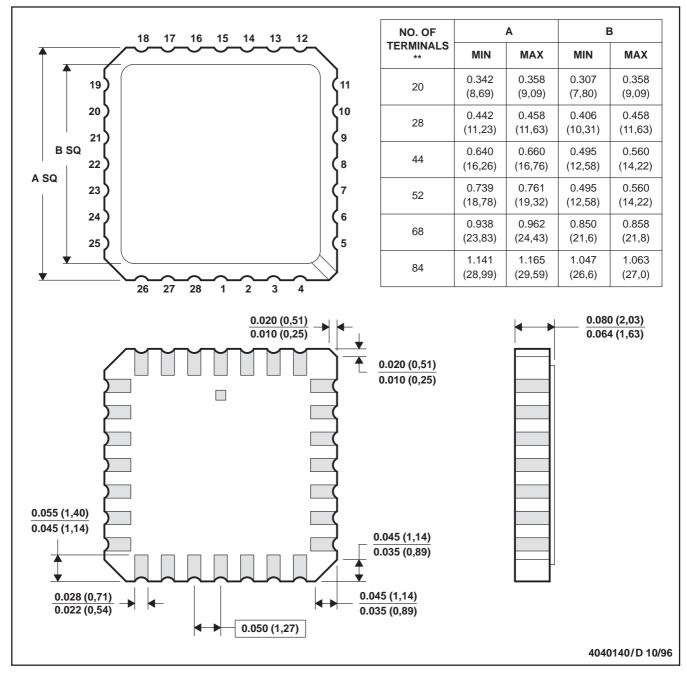
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MLCC006B - OCTOBER 1996

LEADLESS CERAMIC CHIP CARRIER

#### FK (S-CQCC-N\*\*)

**28 TERMINAL SHOWN** 



NOTES: A. All linear dimensions are in inches (millimeters).

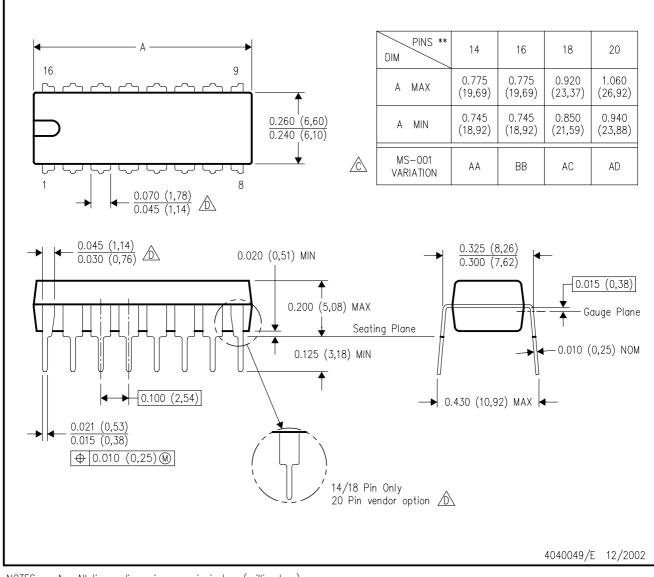
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



PLASTIC DUAL-IN-LINE PACKAGE

## N (R-PDIP-T\*\*)

16 PINS SHOWN



NOTES:

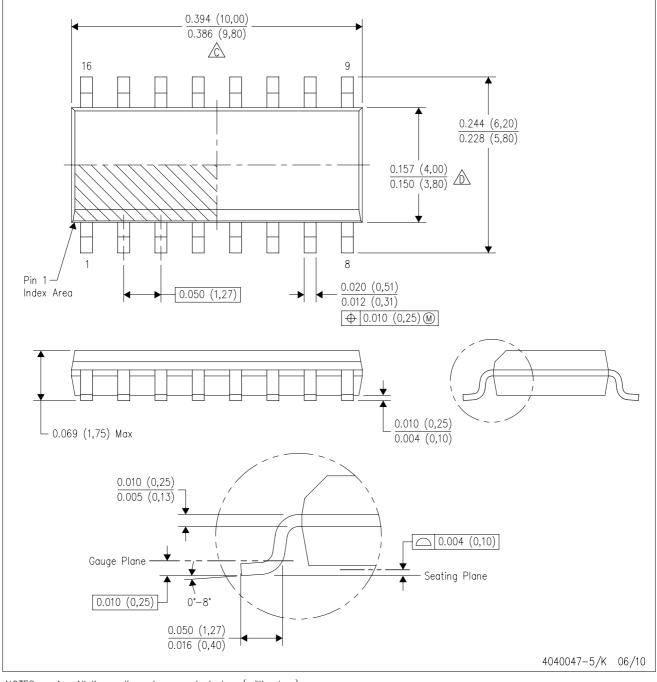
- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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### D (R-PDSO-G16)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



### LAND PATTERN DATA

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## D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) -16x0,55 - 14x1,27 -14x1,27 16x1,95 4,80 4,80 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 Example 2,00 Solder Mask Opening (See Note E) -0,07 All Around

4211283-4/B 09/10

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations. E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

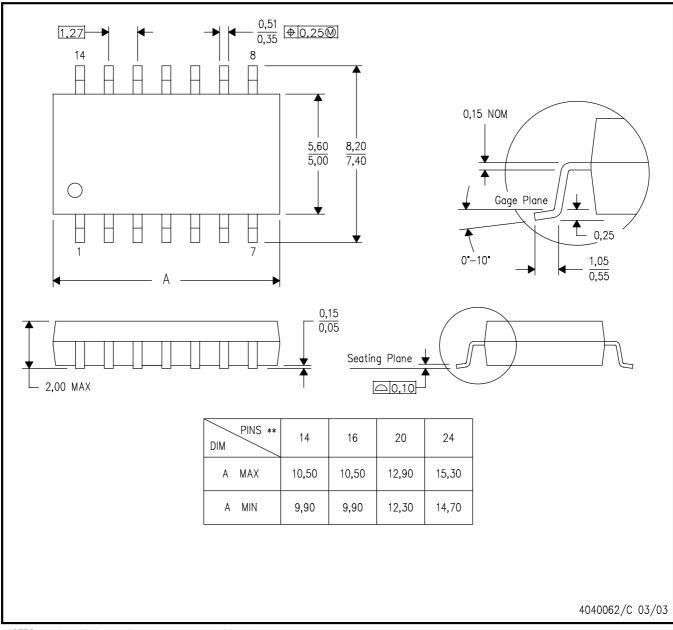


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MECHANICAL DATA

#### NS (R-PDSO-G\*\*) 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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